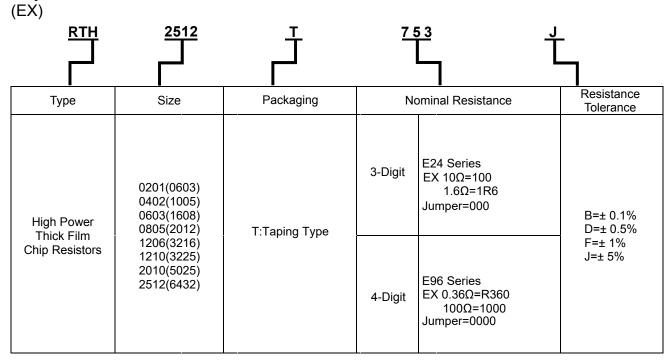


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1 Scope:

- 1.1 This specification is applicable to lead free and halogen free of RoHS directive for RTH series high power thick film chip resistors.
- 1.2 The product is for general electronic purpose.

2 Explanation Of Part Numbers:



	ΙE		QA	Remark	Janua Dan DATA Cantan
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3 **General Specifications:**

Туре	Rated Power at	Max. Working	Max. Overload	T.C.R (ppm/	Resistance Range			Resistance Range JUMPER Rated Power		ted	JUMPER Resistance Value	
	70℃	Voltage	Voltage	℃)	B(±0.1%) E-24 \ E-96	D(±0.5%) E-24 \ E-96	F(±1%) E-24 \ E-96	J(±5%) E-24	J (±5%)	F (±1%)	J (±5%)	F (±1%)
RTH0201	W	25V	50V	-200 +400		1Ω≦R<10Ω	1Ω≦R<10Ω	1Ω≦R<10Ω	0.5A	0.5A	50mΩ	35mΩ
(0603)	16	250	500	±200		$10\Omega {\le} R {\le} 10M\Omega$	$10\Omega {\le} R {\le} 10M\Omega$	$10\Omega {\le} R {\le} 10M\Omega$	U.SA	0.5A	MAX.	MAX.
RTH0402	W	50V	100V	±100	$100\Omega {\le} R {\le} 1M\Omega$	$10\Omega {\le} R {\le} 1M\Omega$	$10\Omega {\le} R {\le} 10M\Omega$	$10\Omega {\le} R {\le} 20M\Omega$	1.5A	2A	50mΩ MAX.	20mΩ
(1005)	8	50 V	100 V	±200			1Ω≦R<10Ω	$1\Omega \le R < 10\Omega$	1.5A	ZA		MAX.
RTH0603	W	75V	150V	±100	$100\Omega {\le} R {\le} 1M\Omega$	$10\Omega {\le} R {\le} 1M\Omega$	$10\Omega {\le} R {\le} 10M\Omega$	$10\Omega {\le} R {\le} 20M\Omega$	1.5A	2.5A	50mΩ MAX.	20mΩ MAX.
(1608)	5	750	150 V	±200		1Ω≦R<10Ω	1Ω≦R<10Ω	$1\Omega \le R < 10\Omega$				
RTH0805	W	150V	300V	±100	$100\Omega {\le} R {\le} 1M\Omega$	$10\Omega {\le} R {\le} 10M\Omega$	$10\Omega {\le} R {\le} 10M\Omega$	$10\Omega {\le} R {\le} 20M\Omega$	2.5A	3.5A	50mΩ MAX.	20mΩ
(2012)	4	150 V	300 V	±200		1Ω≦R<10Ω	1Ω≦R<10Ω	$1\Omega \le R < 10\Omega$				MAX.
RTH1206	W	200V	400V	±100	$10\Omega {\le} R {\le} 1M\Omega$	$10\Omega \! \leq \! R \! \leq \! 10M\Omega$	$10\Omega \! \leq \! R \! \leq \! 10M\Omega$	$10\Omega {\le} R {\le} 20M\Omega$	3A	5A	50mΩ MAX.	20mΩ MAX.
(3216)	2 **	200 V	4000	±200	3Ω≦R<10Ω	1Ω≦R<10Ω	$1\Omega \le R < 10\Omega$	$1\Omega \le R < 10\Omega$	5	56		
RTH1210	3 W	200V	400V	±100	$100\Omega {\le} R {\le} 1M\Omega$	$10\Omega {\le} R {\le} 10M\Omega$	$10\Omega {\le} R {\le} 10M\Omega$	$10\Omega {\le} R {\le} 20M\Omega$	4A	6A	50mΩ MAX.	20mΩ MAX.
(3225)	4	200 V	4000	±200			1Ω≦R<10Ω	$1\Omega \le R < 10\Omega$	47	0/		
RTH2010	1W	200V	400V	±100			$10\Omega {\le} R {\le} 10M\Omega$	$10\Omega {\le} R {\le} 10M\Omega$	4.5A	7A	50mΩ	20mΩ
(5025)	(5025) 1VV	2000	4000	±200			1Ω≦R<10Ω	1Ω≦R<10Ω	4.5A	/A	MAX.	MAX.
RTH2512	2W	200V	400V	±100	100Ω≦R≦100K	100Ω≦R≦100K	10Ω≦R≦10MΩ	10Ω≦R≦10MΩ	6A	10A	50mΩ	20mΩ MAX.
(6432)	∠vv	2007	2007 4007	±200			1Ω≦R<10Ω	1Ω≦R<10Ω	DA	IUA	MAX.	
Oper	Operating Temperature Range -55℃ ~+155℃ (0201:-55℃ ~+125℃)											

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3.1 Power Derating Curve:

Туре	RTH0201 (0603)	Other		
Operating Temperature Range	-55°C ~ +125°C	-55°C ~ +155°C		
Explain	centigrade to 125 degrees centigrade, the power	If the ambient temperature exceeds 70 degrees centigrade to 155 degrees centigrade, the power can be modified by the curve as below.		
Figure	70 80 60 40 20 0 -55 20 40 60 80 100 120 140 160 Ambient Temperature(°C)	70 80 80 60 60 20 20 20 40 60 80 100 155 20 40 40 100 100 100 100 100 100		

3.2 Voltage Rating

Rated Voltage: The resistor shall have a DC continuous working voltage or a rms. AC continuous working voltage at commercial-line frequency and wave form corresponding to the power rating, as determined from the following

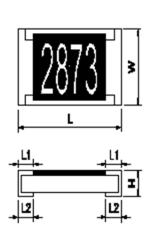
$$E = \sqrt{R \times P}$$
 E= Voltage rating (v) P= Power rating (w) R= Nominal resistance(Ω)



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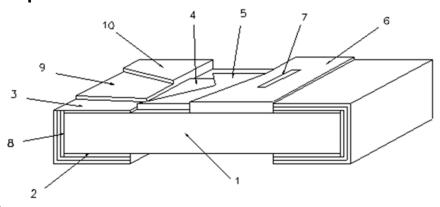
4 Dimensions:

Unit:mm



						Offic.fffiff
	Dimension Size Code	٦	W	н	L1	L2
RTH0201	0603	0.60±0.03	0.30±0.03	0.23±0.03	0.15±0.05	0.15±0.05
RTH0402	1005	1.00±0.10	0.50±0.05	0.30±0.05	0.20±0.10	0.25±0.10
RTH0603	1608	1.55±0.10	0.80±0.10	0.45±0.10	0.30±0.15	0.30±0.15
RTH0805	2012	2.00±0.10	1.25±0.10	0.50±0.10	0.35±0.20	0.35±0.15
RTH1206	3216	3.05±0.10	1.55±0.10	0.50±0.10	0.45±0.20	0.35±0.15
RTH1210	3225	3.05±0.10	2.55±0.10	0.55±0.10	0.50±0.20	0.50±0.20
RTH2010	5025	4.95±0.10	2.45±0.10	0.70±0.10	0.65±0.20	0.60±0.20
RTH2512	6432	6.40±0.20	3.20±0.20	0.70±0.10	0.60±0.20	1.25±0.20

5 Structure Graph:



1	Ceramic substrate	6 2nd Protective coating	
2	Bottom inner electrode 7		Marking
3	Top inner electrode	8	Terminal inner electrode
4	Resistive layer	9	Ni plating
5	1st Protective coating	10	Sn plating

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6 Reliability Test: 6.1 Electrical Performance Test

Item	Conditions	Specifications			
iteiii	Conditions	Resistors	Jumper		
Temperature Coefficient of Resistance	TCR (ppm/°C) = $\frac{(R2-R1)}{R1 (T2-T1)} \times 10^6$ R1: Resistance at room temperature R2: Resistance at -55°C or +125°C T1: Room temperature T2: Temperature -55°C or +125°C	Refer to item 3. general specifications	NA		
Short Time Overload		0.1%、0.5%、1%: ΔR%=±1.0% 5%: ΔR%=±2.0%	Refer to item 3. general specifications		
Insulation Resistance	Put the resistor in the fixture, add 100 VDC in + ,- terminal for 60 sec then measured the insulation resistance between electrodes and insulating enclosure or between electrodes and base material. Refer to JIS-C5201-1 4.6 Metal block measuring plote Point A Metal plote measuring point B Specimen Pressurizing by spring Insulating enclosure surface RO.5mm	$\geq 10^{9}\Omega$			
Dielectric Withstand Voltage	Put the resistor in the fixture, add VAC (see spec. below) in +,- terminal for. RTH0805 \ 1206 \ 1210 \ \ 2010 \ 2512 apply 500 VAC 1 minute. RTH0402 \ 0603 apply 300 VAC 1 minute. Refer to JIS-C5201-1 4.7	No short or burned on the appe	earance.		

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6.2 Mechanical Performance Test

Conditions	Specifications		
	Resistors	Jumper	
Test1:The resistor mounted on the board applied 5N (RTH0201:3N)pushing force on the sample rear for 10sec. Test2:The resistor mounted on the board slowly add force on the sample rear until the sample termination is breakdown. Refer to JIS-C5201-1 4.16	Test2:RTH0201≧3N	al damage	
The tested resistor be immersed into isopropyl alcohol of 20~25°C for 5 minutes, then the resistor is left in the room for 48 hrs, and measured its resistance variance rate. Refer to JIS-C5201-1 4.29	Other type:∆R%=±0.5%	Refer to item 3. general specifications	
Preconditioning: Put the tested resistor in the apparatus of PCT, at a temperature of 105°C, humidity of 100% RH, and pressure of 1.22×10 ⁵ Pa for a duration of 4 hours. Then after left the tested resistor in room temperature for 2 hours or more. Test method: The resistor be immersed into solder pot in temperature 235±5°C for 2 sec, then the resistor is left as placed under microscope to observed its solder area. Refer to JIS-C5201-1 4.17	Solder coverage over 95%		
Test method 1 (solder pot test): The tested resistor be immersed into molten solder of 260+5/-0°C for 10+1/-0 seconds. Then the resistor is left in the room for 1 hour. Test method 2 (solder pot test): The tested resistor be immersed into molten solder of 260+5/-0°C for 30+1/-0 seconds. Then the resistor is left as placed under microscope to observe its solder area. Test method 3 (Electric iron test): Preheating temperature: 350±10°C Electric iron preheating time: 3+1/-0 sec Preheating the electric iron on electrode termination, as after that step placed the iron over 60 min. and measured its resistance variance rate. Refer to JIS-C5201-1 4.18		Refer to item 3. general specifications	
	Test1:The resistor mounted on the board applied 5N (RTH0201:3N)pushing force on the sample rear for 10sec. Test2:The resistor mounted on the board slowly add force on the sample rear until the sample termination is breakdown. Refer to JIS-C5201-1 4.16 The tested resistor be immersed into isopropyl alcohol of 20~25°C for 5 minutes, then the resistor is left in the room for 48 hrs, and measured its resistance variance rate. Refer to JIS-C5201-1 4.29 Preconditioning: Put the tested resistor in the apparatus of PCT, at a temperature of 105°C, humidity of 100% RH, and pressure of 1.22×10⁵ Pa for a duration of 4 hours. Then after left the tested resistor in room temperature for 2 hours or more. Test method: The resistor be immersed into solder pot in temperature 235±5°C for 2 sec, then the resistor is left as placed under microscope to observed its solder area. Refer to JIS-C5201-1 4.17 Test method 1 (solder pot test): The tested resistor be immersed into molten solder of 260+5/-0°C for 10+1/-0 seconds. Then the resistor is left in the room for 1 hour. Test method 2 (solder pot test): The tested resistor be immersed into molten solder of 260+5/-0°C for 30+1/-0 seconds. Then the resistor is left as placed under microscope to observe its solder area. Test method 3 (Electric iron test): Preheating temperature : 350±10°C Electric iron preheating time : 3+1/-0 sec Preheating the electric iron on electrode termination, as after that step placed the iron over 60 min. and measured its resistance variance rate.	Test1:The resistor mounted on the board applied 5N (RTH0201:3N)pushing force on the sample rear for 10sec. Test2:The resistor mounted on the board slowly add force on the sample rear until the sample termination is breakdown. Refer to JIS-C5201-1 4.16 The tested resistor be immersed into isopropyl alcohol of 20-25℃ for 5 minutes, then the resistor is left in the room for 48 hrs, and measured its resistance variance rate. Refer to JIS-C5201-1 4.29 Preconditioning: Put the tested resistor in the apparatus of PCT, at a temperature of 105℃, humidity of 100% RH, and pressure of 1.22×10⁵ Pa for a duration of 4 hours. Then after left the tested resistor in room temperature for 2 hours or more. Test method: The resistor be immersed into solder pot in temperature 235±5℃ for 2 sec, then the resistor is left as placed under microscope to observed its solder area. Refer to JIS-C5201-1 4.17 ○Test method 1 (solder pot test): The tested resistor be immersed into molten solder of 260+5/-0℃ for 10+1/-0 seconds. Then the resistor is left in the room for 1 hour. □Test method 2 (solder pot test): The tested resistor be immersed into molten solder of 260+5/-0℃ for 30+1/-0 seconds. Then the resistor is left as placed under microscope to observe its solder area. □Test method 3 (Electric iron test): Preheating temperature: 350±10℃ Electric iron preheating time: 3+1/-0 sec Preheating the electric iron on electrode termination, as after that step placed the iron over 60 min. and measured its resistance variance rate.	

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Item	Conditions	Specifications		
ILCIII	Conditions	Resistors	Jumper	
	Solder tested resistor on to PC board. Add force in the middle down, and under load measured its resistance variance rate. D:RTH0402 ⋅ 0603 ⋅ 0805=5mm RTH0201 ⋅ 1206 ⋅ 1210=3mm RTH2010 ⋅ 2512=2mm Resistor Testing circuit board Solder Supporting jig Preseurts (Arrount of bend)	ΔR%=±1.0%	Refer to item 3. general specifications	
	Refer to JIS-C5201-1 4.33			

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6.3 Environmental Test

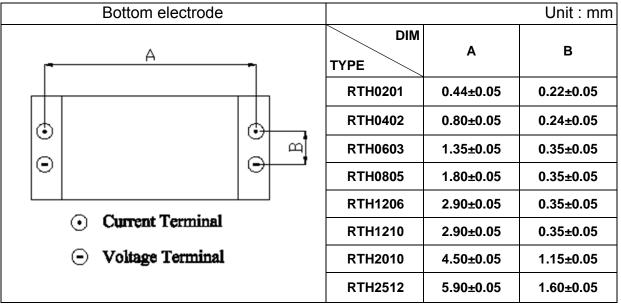
Itom	Conditions		Specifications		
Item			Re	sistors	Jumper
Resistance to Dry Heat	155±5°C for 1000 +48/-0 hours. Then leaving the esistance to tested resistor in room temperature for 60 minutes,		0.1%、0.5%、 △R%=±1.0% 5%: △R%=±2.0%	.,	Refer to item 3. general specifications
	Refer to JIS-C5201-1 4.25				
Thermal Shock which shown in the following table shall be repeated 300 times consecutively. Then leaving the tested resistor in the room temperature for 1 hours, and measure its resistance variance		0.1%、0.5%、 △R%=±0.5% 5%: △R%=±1.0%		Refer to item 3. general specifications	
Thermal Shock	Testing Condi	tion			
	Lowest Temperature	-55±5°C			
	Highest Temperature	125±5℃			
	Temperature-retaining time	15 minutes each			
	Refer to MIL-STD 202 Method				
Loading Life in Moisture	temperature $40\pm2^{\circ}$ C, relative humidity $90\sim95\%$ and load the rated voltage for 90 minutes on, 30 minutes off, total 1000 hours. Then leaving the tested resistor		∆R%=±2.0%	.,	Refer to item 3. general specifications
	Refer to JIS-C5201-1 4.24				
Load Life	temperature 70±2°C and load the rated voltage for 90 minutes on, 30 minutes off, total 1000 hours.		0.1%、0.5%、 △R%=±0.5% 5%: △R%=±2.0%	1%:	Refer to item 3.general specifications
	Refer to JIS-C5201-1 4.25				

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7 Measurement Point:



8 Plating Thickness:

8.1 Ni:≧2µm

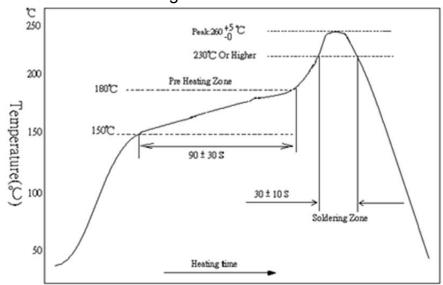
8.2 Sn(Tin): ≥3µm8.3 Sn(Tin): Matte Sn

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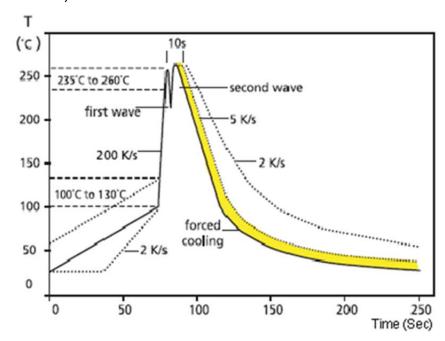
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- 9 Technical application notes: (This is for recommendation, please customer perform adjustment according to actual application)
 - 9.1 Recommend Soldering Method:
 - 9.1.1 Lead Free IR Reflow Soldering Profile



Remark1:Recommended IR Reflow Soldering Profile meet J-STD-020D. Remark2:The peak temperature of soldering heat is 260 +5/-0 °C for 10 seconds.

9.1.2 Lead Free Double-Wave Soldering Profile. (This applies to 0603 size inclusive above products)



9.1.3 Soldering Iron: temperature $350^{\circ}\text{C} \pm 10^{\circ}\text{C}$, dwell time shall be less than 3 sec.

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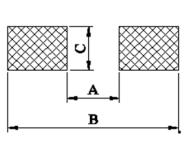


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9.2 Recommend Land Pattern Design (For Reflow Soldering):

When a component is soldered, the resistance after soldering changes slightly depending on the size of the soldering area and the amount of soldering. When designing a circuit, it is necessary to consider the effect of a decrease or increase in its resistance.

Unit:mm



TYPE	Α	В	С
RTH0201	0.3	1.0	0.4
RTH0402	0.5	1.5	0.6
RTH0603	8.0	2.1	0.9
RTH0805	1.2	3.0	1.3
RTH1206	2.2	4.2	1.6
RTH1210	2.2	4.2	2.8
RTH2010	3.5	6.1	2.8
RTH2512	3.8	8.0	3.5

9.3 Environment Precautions:

This specification product is for general electronic use, ABCO will not be responsible for any damage, cost or loss caused by using this specification product in any special environment. If other applications need to confirm with ABCO.

If consumer intends to use our Company product in special environment or condition (including but not limited to those mentioned below), then will need to make individual recognition of product features and reliability accordingly.

- (a) Used in high temperature and humidity environment
- (b) Exposed to sea breeze or other corrosive gas, such as Cl2 \ H2S \ NH3 \ SO2 and NO2.
- (c) Used in non-verified liquids including water, oil, chemical and organic solvents.
- (d) Using non-verified resin or other coating material to seal or coat our Company product.
- (e) After soldering, it is necessary to use water-soluble detergents to clean residual solder fluxes, even though no-clean fluxes are recommended.

9.4 Momentary Overload Precautions:

The product might be out of function when momentary overloaded. Please make sure to avoid momentary overloading while using and preserving •

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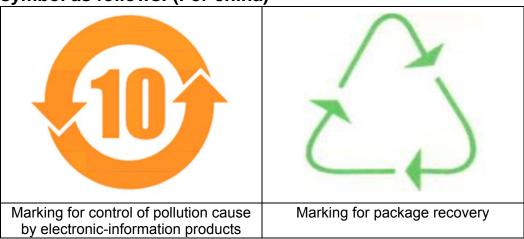
9.5 Operation and Processing Precautions:

- (a) Avoid damage to the edge of resistor and protective layer caused by mechanical stress.
- (b) Handle with care when printing circuit board (PCB) is divided or fixed on support body, because bending of printing circuit board (PCB) mounting will make mechanical stress for resistors.
- (c) Make sure the power rating is under the limit when using the resistor. When power rating is over the limit, the resister will be overloaded. There might be machinery damage due to the climbing temperature.
- (d) If the resister will be exposed under massive impact load (shock wave) in a short period of time, the working environment must be set up well before use.
- (e) Please make evaluation and confirmation when the product is well used in your company and have a through consideration of it's fail-safe design to ensure the system safety.

10 Storage and transportation requirement:

- 10.1 The temperature condition must be controlled as 25±5°C, the R.H. must be controlled as 60±15%. The stock can maintain quality level in two years.
- 10.2 Please avoid the mentioned harsh environment below when storing to ensure product performance and its'weldability. Places exposed to sea breeze or other corrosive gas, such as Cl2 \ H2S \ NH3 \ SO2 and NO2.
- 10.3 When the product is moved and stored, please ensure the correct orientation of the box. Do not drop or squeeze the box. Otherwise, the electrode or the body of the product may be damaged.

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